OptiMOS™ 3 M-Series Power-MOSFET

Features

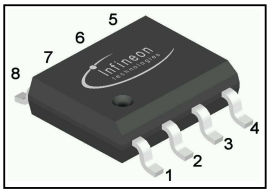
- Optimized for 5V driver application (Notebook, VGA, POL)
- Low FOM_{SW} for High Frequency SMPS
- 100% Avalanche tested
- N-channel
- Very low on-resistance $R_{DS(on)}$ @ V_{GS}=4.5 V
- Excellent gate charge x $R_{DS(on)}$ product (FOM)
- Qualified for consumer level application
- Pb-free plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

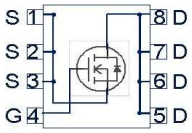
RoHS Halogen-Free

Product Summary

V_{DS}		30	V
$R_{DS(on),max}$	V_{GS}=10 V	8.3	mΩ
	V_{GS}=4.5 V	10.5	
I_D		14	A

PG-DSO-8





Type	Package	Marking
BSO083N03MS G	PG-DSO-8	083N03MS

Maximum ratings, at T_j=25 ℃, unless otherwise specified

Parameter	Symbol	Conditions	Value		Unit
			10 secs	steady state	
Continuous drain current[1]	I_D	V_{GS}=10 V, T_A=25 ℃	14	11	A
		V_{GS}=10 V, T_A=90 ℃	9.7	7.6	
		V_{GS}=4.5 V, T_A=25 ℃	12.4	9.8	
		V_{GS}=4.5 V, T_A=90 ℃	8.6	6.8	
Pulsed drain current[2]	$I_{D,pulse}$	T_A=25 ℃	98		
Avalanche current, single pulse[3]	I_{AS}	T_A=25 ℃	14		
Avalanche energy, single pulse	E_{AS}	I_D=14 A, R_{GS}=25 Ω	35		mJ
Gate source voltage	V_{GS}		±20		V
Power dissipation[1]	P_{tot}	T_A=25 ℃	2.5	1.56	W
Operating and storage temperature	T_j, T_{stg}		-55 ... 150		℃
IEC climatic category; DIN IEC 68-1			55/150/56		

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal characteristics						
Thermal resistance, junction - soldering point	R_{thJS}		-	-	35	K/W
Thermal resistance, junction - ambient	R_{thJA}	minimal footprint, t_p≤10 s	-	-	110	
		minimal footprint, steady state	-	-	150	
		6 cm^2 cooling area[1)], t_p≤10 s	-	-	50	
		6 cm^2 cooling area[1)], steady state	-	-	80	
Electrical characteristics, at T_j=25 ℃, unless otherwise specified						
Static characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS}=0 V, I_D=1 mA	30	-	-	V
Gate threshold voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=250 µA	1	-	2	
Zero gate voltage drain current	I_{DSS}	V_{DS}=30 V, V_{GS}=0 V, T_j=25 ℃	-	0.1	10	µA
		V_{DS}=30 V, V_{GS}=0 V, T_j=125 ℃	-	10	100	
Gate-source leakage current	I_{GSS}	V_{GS}=16 V, V_{DS}=0 V	-	10	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	V_{GS}=4.5 V, I_D=12.4 A	-	8.4	10.5	mΩ
		V_{GS}=10 V, I_D=14 A	-	6.9	8.3	
Gate resistance	R_G		0.5	1	1.8	Ω
Transconductance	g_{fs}	|V_{DS}|>2|I_D|$R_{DS(on)max}$, I_D=14 A	20	39	-	S

[1)] Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

[2)] See figure 3 for more detailed information

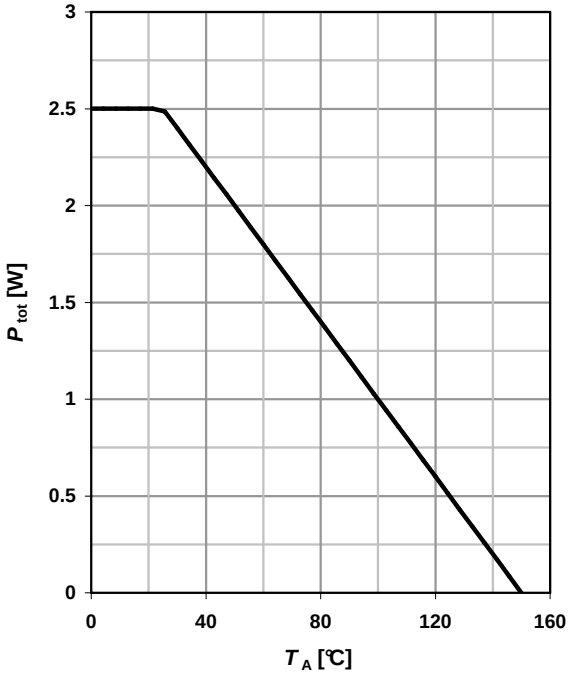
[3)] See figure 13 for more detailed information

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Dynamic characteristics						
Input capacitance	C_{iss}	V_{GS}=0 V, V_{DS}=15 V, f=1 MHz	-	1600	2100	pF
Output capacitance	C_{oss}		-	510	680	
Reverse transfer capacitance	C_{rss}		-	33	-	
Turn-on delay time	$t_{d(on)}$	V_{DD}=15 V, V_{GS}=4.5 V, I_D=14 A, R_G=1.6 Ω	-	9.4	-	ns
Rise time	t_r		-	5	-	
Turn-off delay time	$t_{d(off)}$		-	11.5	-	
Fall time	t_f		-	5.4	-	
Gate Charge Characteristics[4)]						
Gate to source charge	Q_{gs}	V_{DD}=15 V, I_D=14 A, V_{GS}=0 to 4.5 V	-	4.5	-	nC
Gate charge at threshold	$Q_{g(th)}$		-	2.5	-	
Gate to drain charge	Q_{gd}		-	2.2	-	
Switching charge	Q_{sw}		-	4.2	-	
Gate charge total	Q_g		-	9.9	13	
Gate plateau voltage	$V_{plateau}$		-	2.9	-	V
Gate charge total	Q_g	V_{DD}=15 V, I_D=14 A, V_{GS}=0 to 10 V	-	21	27	nC
Gate charge total, sync. FET	$Q_{g(sync)}$	V_{DS}=0.1 V, V_{GS}=0 to 4.5 V	-	8.6	11.4	
Output charge	Q_{oss}	V_{DD}=15 V, V_{GS}=0 V	-	13.4	18	
Reverse Diode						
Diode continuous forward current	I_S	T_A=25 ℃	-	-	3	A
Diode pulse current	$I_{S,pulse}$		-	-	98	
Diode forward voltage	V_{SD}	V_{GS}=0 V, I_F=14 A, T_j=25 ℃	-	0.85	1.1	V
Reverse recovery charge	Q_{rr}	V_R=15 V, I_F=I_S, di_F/dt=400 A/µs	-	-	10	nC

[4)] See figure 16 for gate charge parameter definition

1 Power dissipation

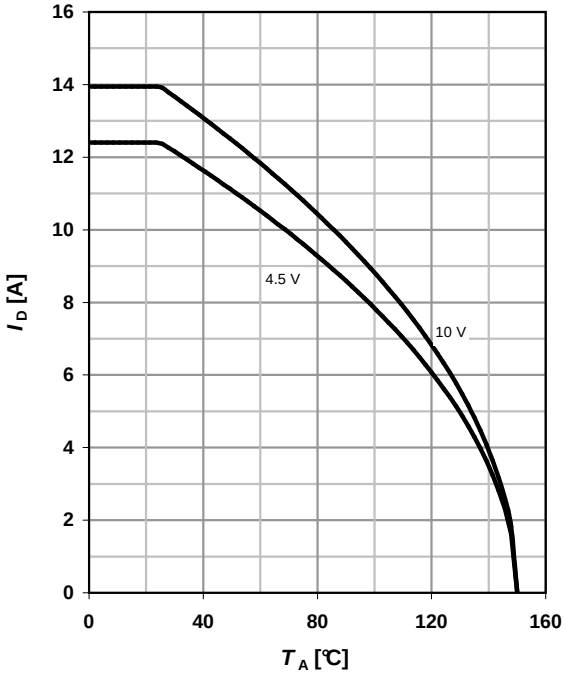
$P_{tot}=f(T_A)$; $t_p \leq 10$ s



2 Drain current

$I_D=f(T_A)$; $t_p \leq 10$ s

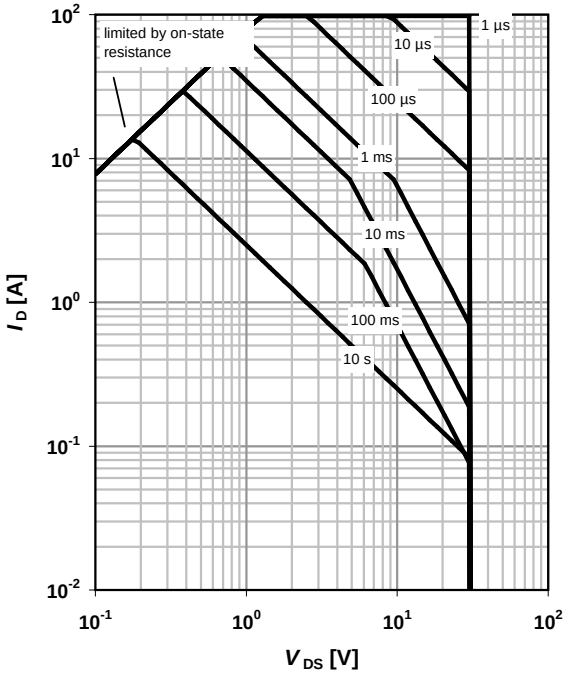
parameter: V_{GS}



3 Safe operating area

$I_D=f(V_{DS})$; $T_A=25$ ℃ [2]; $D=0$

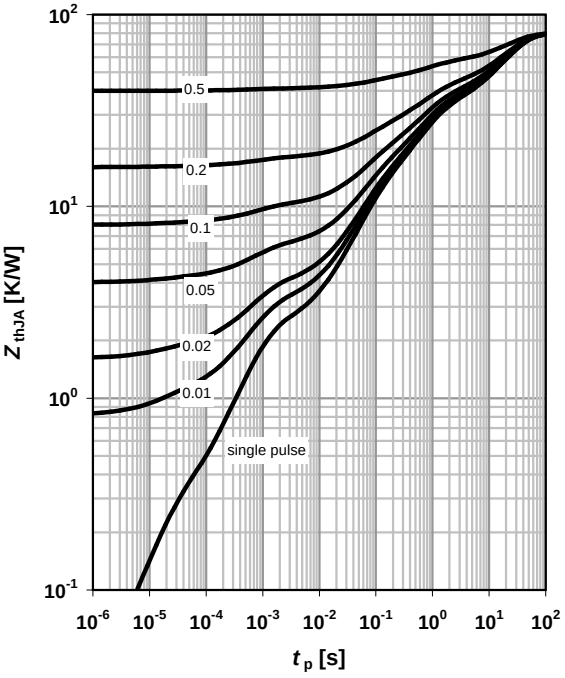
parameter: t_p



4 Max. transient thermal impedance

$Z_{thJA}=f(t_p)$ [2]

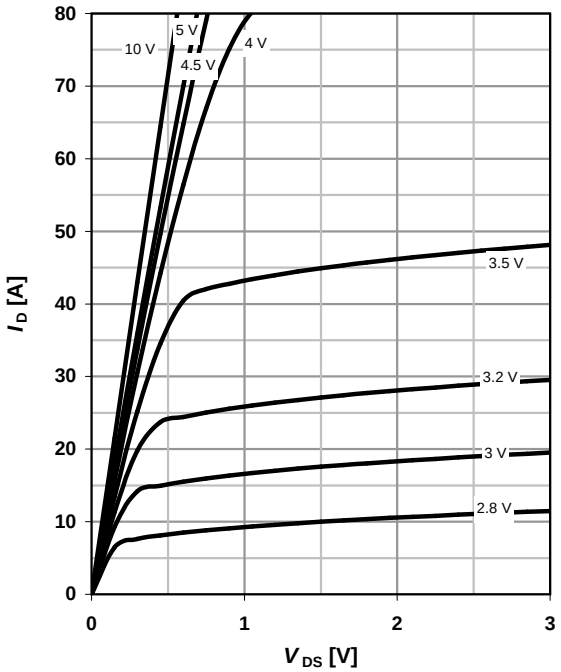
parameter: $D=t_p/T$



5 Typ. output characteristics

I_D=f(V_{DS}); T_j=25 ℃

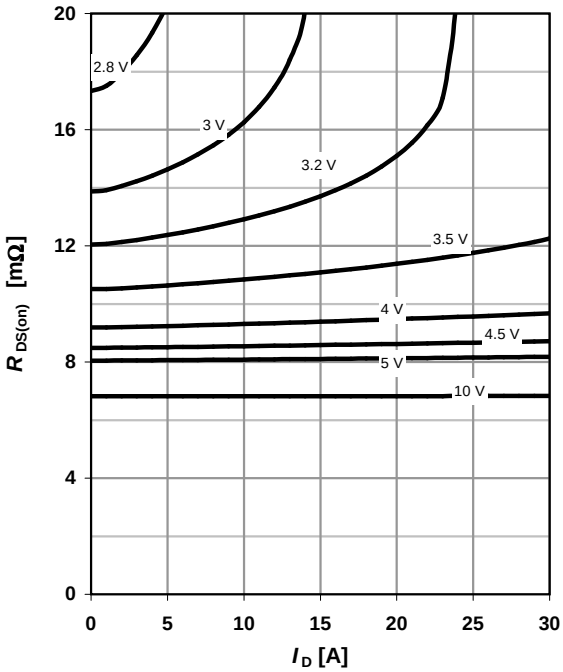
parameter: V_{GS}



6 Typ. drain-source on resistance

$R_{DS(on)}$=f(I_D); T_j=25 ℃

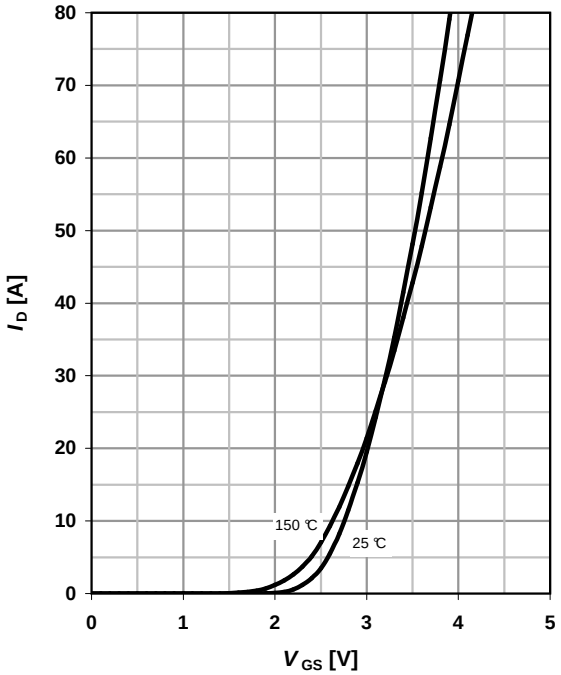
parameter: V_{GS}



7 Typ. transfer characteristics

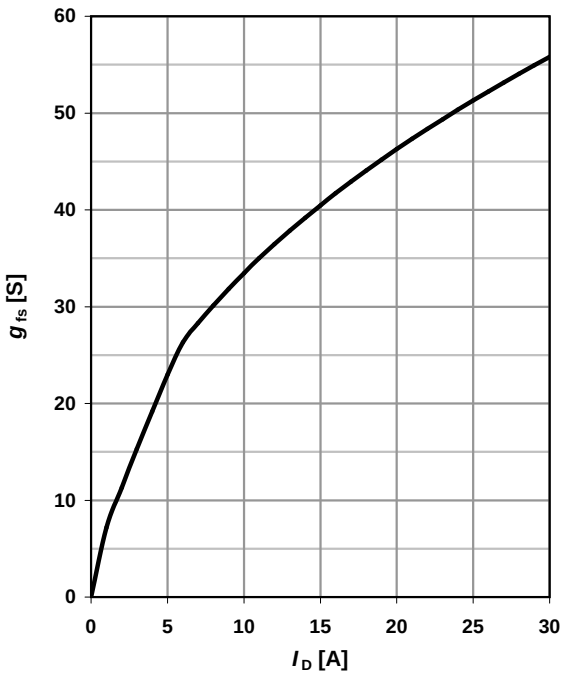
I_D=f(V_{GS}); $|V_{DS}|>2|I_D|R_{DS(on)max}$

parameter: T_j



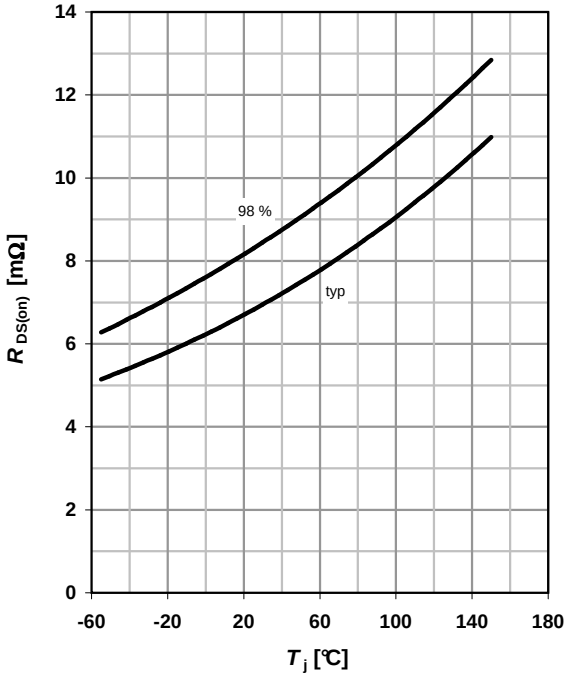
8 Typ. forward transconductance

g_{fs}=f(I_D); T_j=25 ℃



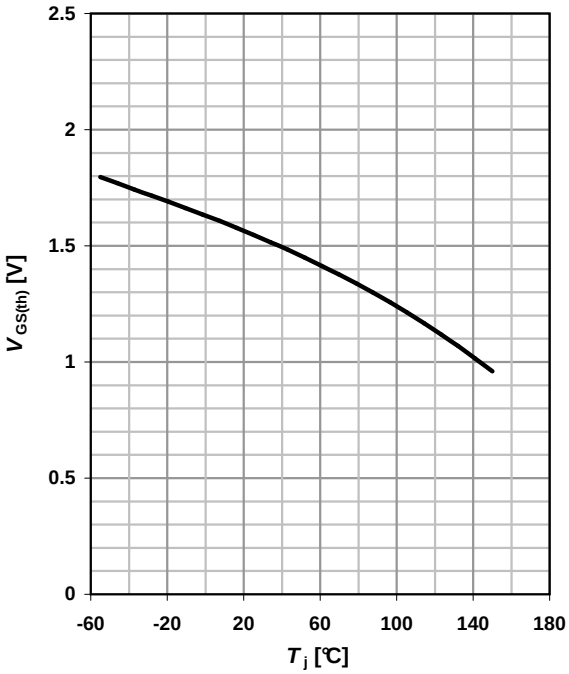
9 Drain-source on-state resistance

$R_{DS(on)}$=f(T_j); I_D=14 A; V_{GS}=10 V



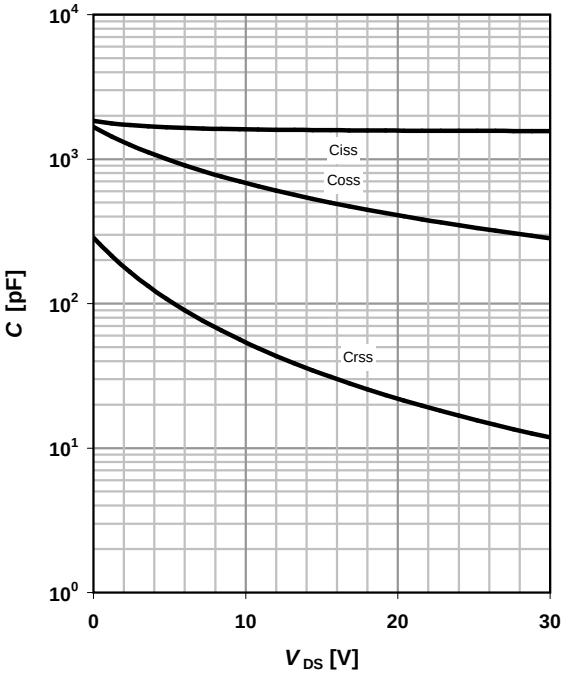
10 Typ. gate threshold voltage

$V_{GS(th)}$=f(T_j); V_{GS}=V_{DS}; I_D=250 µA



11 Typ. capacitances

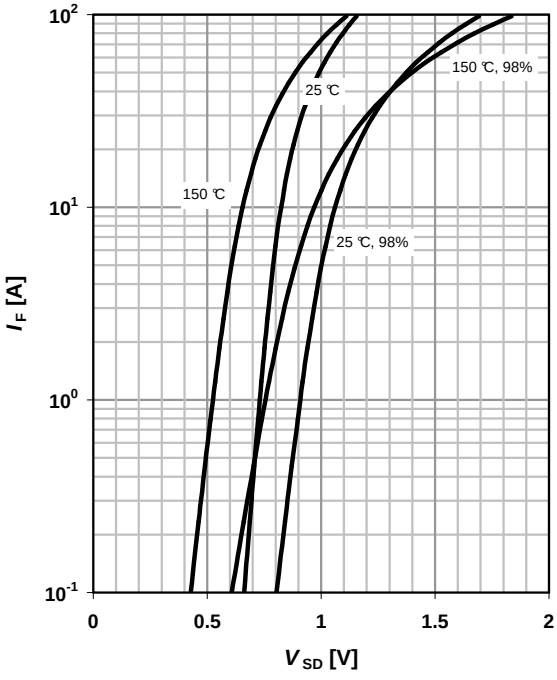
C=f(V_{DS}); V_{GS}=0 V; f=1 MHz



12 Forward characteristics of reverse diode

I_F=f(V_{SD})

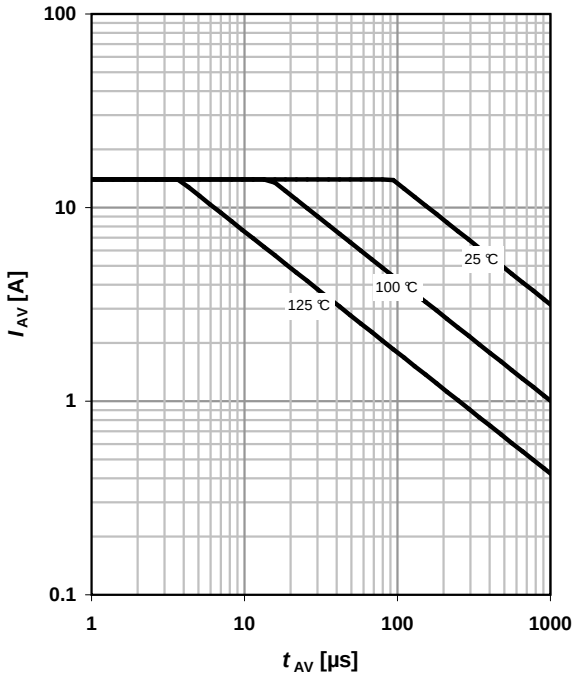
parameter: T_j



13 Avalanche characteristics

I_{AS}=f(t_{AV}); R_{GS}=25 Ω

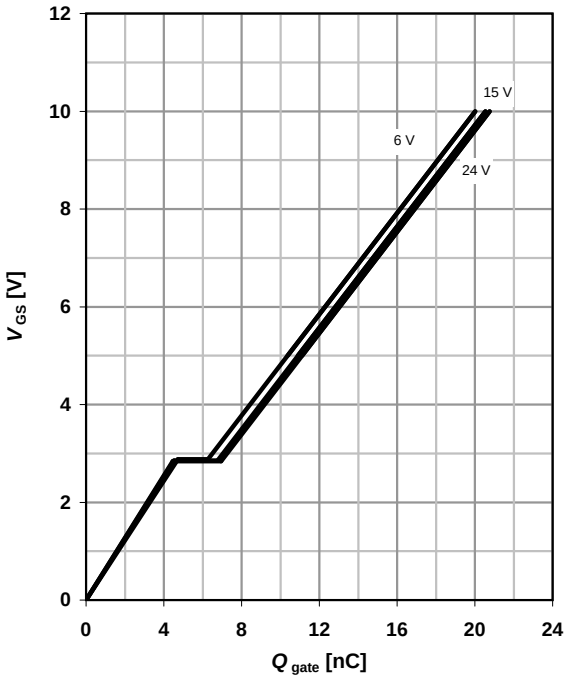
parameter: $T_{j(start)}$



14 Typ. gate charge

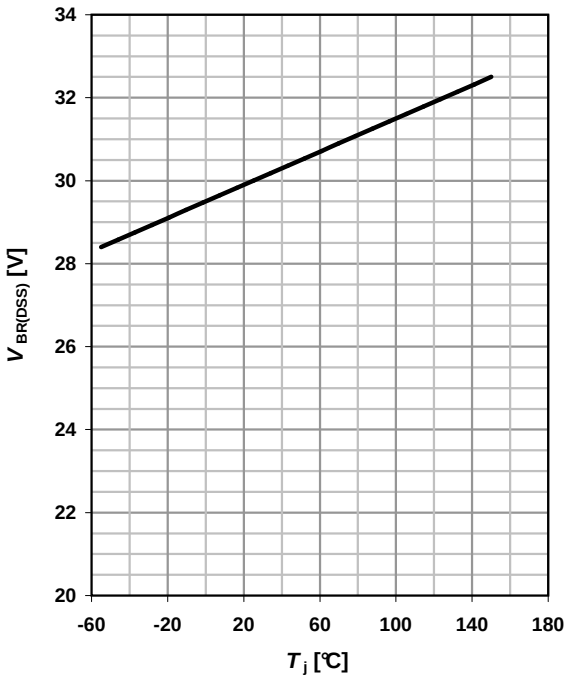
V_{GS}=f(Q_{gate}); I_D=14 A pulsed

parameter: V_{DD}

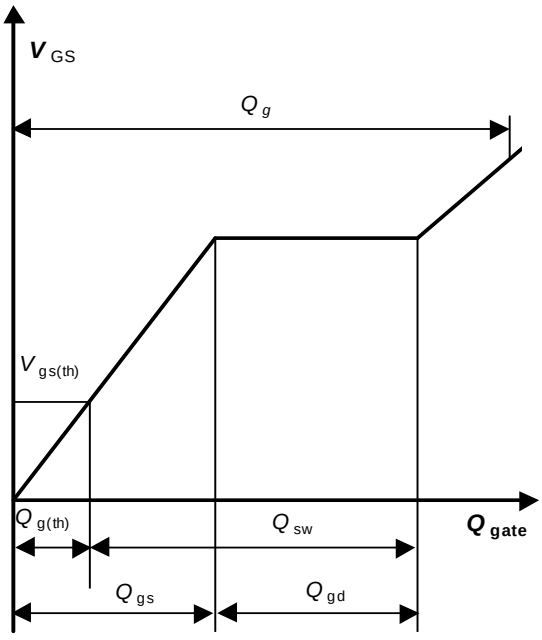


15 Drain-source breakdown voltage

$V_{BR(DSS)}$=f(T_j); I_D=1 mA

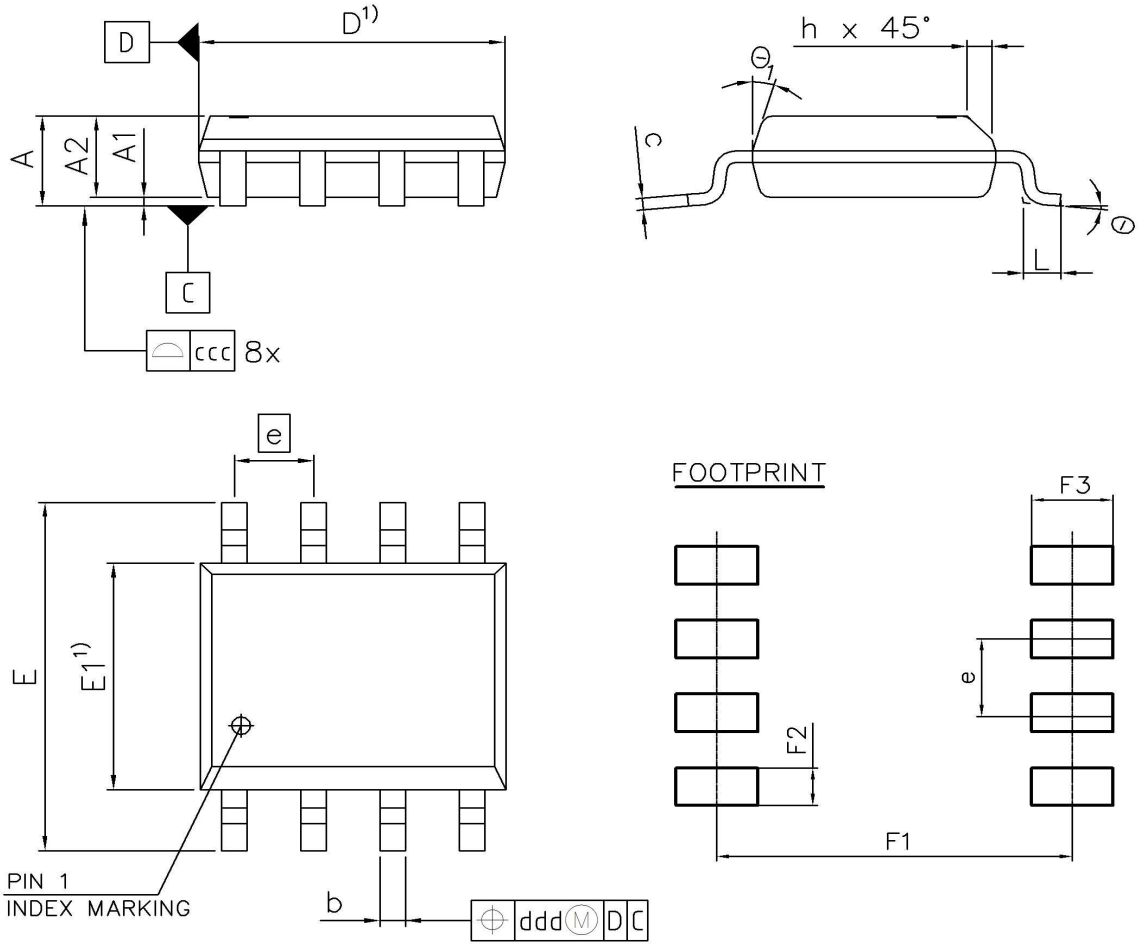


16 Gate charge waveforms



Package Outline

PG-DSO-8: Outline



1) DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	-	1.75	-	0.069
A1	0.10	-	0.004	-
A2	1.25	1.65	0.049	0.065
b	0.35	0.51	0.014	0.020
c	0.17	0.25	0.007	0.010
D	4.80	5.00	0.189	0.197
E	5.80	6.20	0.228	0.244
E1	3.80	4.00	0.150	0.157
e	1.27		0.050	
N	8		8	
L	0.39	0.89	0.015	0.035
h	0.23	0.50	0.009	0.020
Θ	0°	8°	0°	8°
Θ1	-	19°	-	19°
ccc	0.10		0.004	
ddd	0.25		0.010	
F1	5.59	5.79	0.220	0.228
F2	0.55	0.75	0.022	0.030
F3	1.21	1.41	0.048	0.056

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SCALE 0 1.0 0 1.0 2mm

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